

MODEL: HSB24-252510 | DESCRIPTION: HEAT SINK

FEATURES

- BGA design
- small footprint
- top mount
- aluminum alloy





| MODEL | thermal resistance ¹ | | | | power dissipation ¹ |
|--------------|--------------------------------------|-------------------------------------|------------------------------------|-----------------------------|-----------------------------------|
| | @ 75°C ΔT, nat conv (°C/W) | @ 1 W, nat conv (°C/W) | @ 1 W, 200 LFM (°C/W) | @ 1 W, 400 LFM (°C/W) | @ 75°C ∆T, nat conv (W) |
| HSB24-252510 | 18.10 | 21.3 | 6.5 | 4.0 | 4.14 |
| | | | | | |

Note: 1. See performance curves for full thermal resistance details.

PERFORMANCE CURVES

| | Heatsink Temperature Rise Above Ambient (ΔT = Ths - Ta) (°C) | | | |
|--------------|---|---------|---------|--|
| Power (W) | Natural Conv. | 200 LFM | 400 LFM | |
| 0 | 0 | O | 0 | |
| 1 | 21.3 | 6.5 | 4.0 | |
| 2 | 40.6 | 12.9 | 7.8 | |
| 3 | 57.3 | 19.5 | 11.5 | |
| 4 | 73.0 | 26.2 | 15.5 | |
| 5 | 86.9 | 32.5 | 19.5 | |
| 6 | 100.6 | 39.1 | 23.4 | |
| 7 | 113.8 | 46.0 | 27.5 | |
| 8 | 125.9 | 52.5 | 31.6 | |

150 Without Airflow 200 LFM 400 LFM 0 0 2 400 LFM 6 8 100 0 2 4 Heat Dissipated (W) 8 100

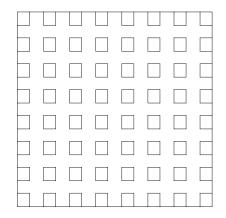
Ths: "hot spot" temperature measured on the heatsink Ta: ambient temperature

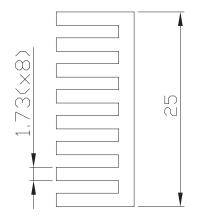
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MECHANICAL DRAWING

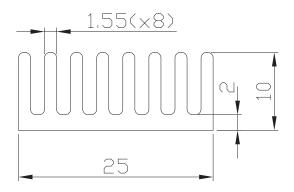
units: mm tolerance: ±0.5 mm

| MATERIAL | AL 6063-T5 |
|----------|----------------|
| FINISH | black anodized |
| WEIGHT | 8.8 g |





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REVISION HISTORY

| rev. | description | date |
|------|------------------------------|------------|
| 1.0 | initial release | 04/22/2022 |
| 1.01 | logo, datasheet style update | 08/05/2022 |

The revision history provided is for informational purposes only and is believed to be accurate.

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